## 2SB1073

### Silicon PNP epitaxial planer type

#### For low-frequency amplification

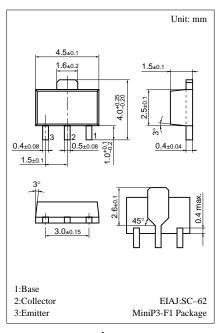
#### Features

- Low collector to emitter saturation voltage V<sub>CE(sat)</sub>.
- Large peak collector current I<sub>CP</sub>.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	-30	V
Collector to emitter voltage	$V_{CEO}$	-20	V
Emitter to base voltage	$V_{\rm EBO}$	-7	V
Peak collector current	$I_{CP}$	-7	A
Collector current	$I_{C}$	-4	A
Collector power dissipation	${P_C}^*$	1	W
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	<b>−55 ~ +150</b>	°C

<sup>\*</sup> Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion



Marking symbol: I

### Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = -30V, I_E = 0$			-100	nA
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -7V, I_C = 0$			-100	nA
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = -10 \mu A, I_{\rm E} = 0$	-30			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{C} = -1 \text{mA}, I_{B} = 0$	-20			V
Emitter to base voltage	V <sub>EBO</sub>	$I_{E} = -10\mu A, I_{C} = 0$	-7			V
Forward current transfer ratio	h <sub>FE</sub> *1	$V_{CE} = -2V, I_C = -2A^{*2}$	120		315	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -3A, I_B = -0.1A^{*2}$		- 0.6	-1	V
Transition frequency	$f_T$	$V_{CB} = -6V, I_E = 50mA, f = 200MHz$		120		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -20V, I_E = 0, f = 1MHz$		40		pF

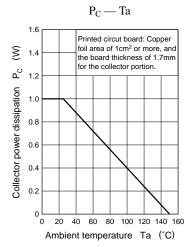
<sup>\*2</sup> Pulse measurement

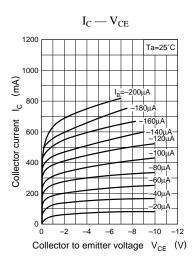
<sup>\*1</sup>hFE Rank classification

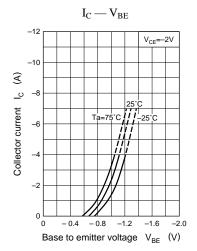
Rank	Q	R		
h <sub>FE</sub>	120 ~ 205	180 ~ 315		
Marking Symbol	IQ	IR		

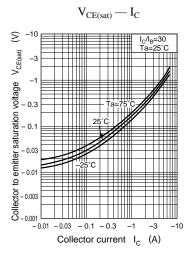
226 Panasonic

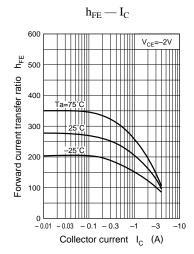
Transistor 2SB1073

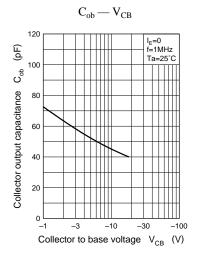












Panasonic 227

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